## 502608607 12/19/2013

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
CHANG-SHENG LIN	12/11/2013
HSIN-HSIEN LU	12/11/2013

## RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. VI
Internal Address:	HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14134091

## CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	T5057-985
NAME OF SUBMITTER:	RANDY A. NORANBROCK
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Date:	12/19/2013

Total Attachments: 1

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PATENT REEL: 031819 FRAME: 0195 OP \$40.00 14134091

Docket No. T5057-985 TSMC2013-1379

# ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- 1) Chang-Sheng LIN
- 2) Hsin-Hsien LU

**RECORDED: 12/19/2013** 

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

# CARRIER HEAD HAVING RETAINER RING, POLISHING SYSTEM INCLUDING THE CARRIER HEAD AND METHOD OF USING THE POLISHING SYSTEM

(a)	for which an application for United States Letters Patent was filed on <u>December 19, 2013</u> , and identified by United States Patent Application No. <u>14/134,091</u> ; or
(b)	for which an application for United States Letters Patent was executed on,
all Unite continua Property	undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and add states Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or ations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned hat the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further renumeration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNBD on the date indicated aside my signature:

1) Uhung - Sheng L3W >0/3, /2, //
Name: Chang-Sheng L1N Date:

2V Hsin - Hsin - Hsien LU Date:

PATENT REEL: 031819 FRAME: 0196